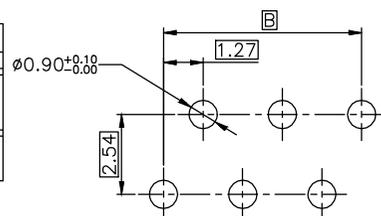
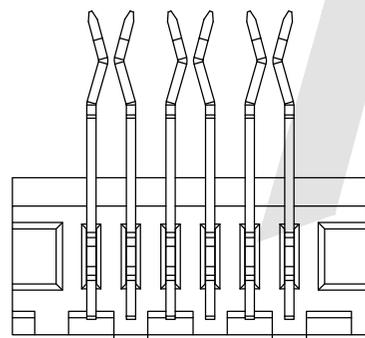
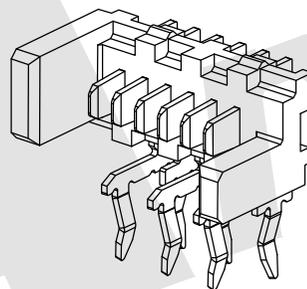
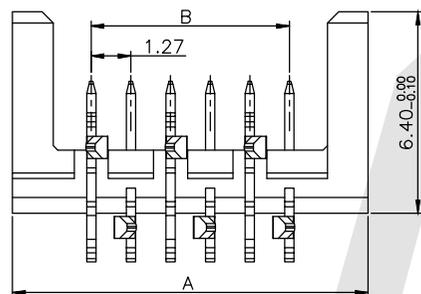
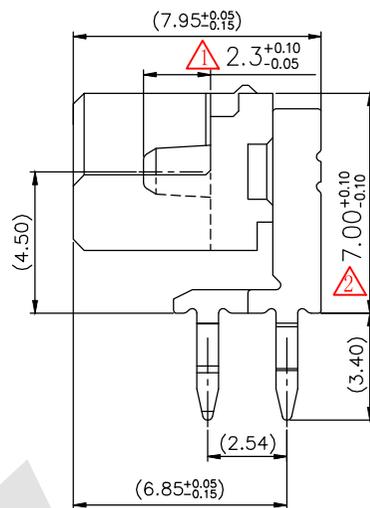
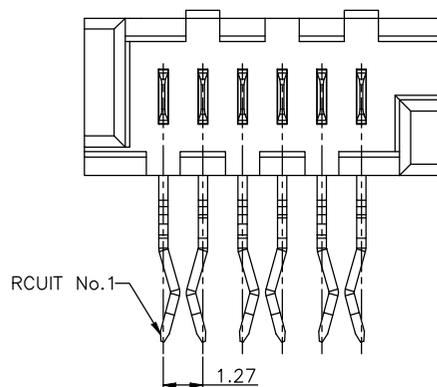


HSF



RECOMMENDED P.C.B LAYOUT FROM COMPONENT SIDE
PCB THICKNESS (1.60±0.20)

Specifications (特性):

Current Rating (额定电流): 2.4A Max
 Contact Resistance (接触阻抗): 20 milliohms MAX
 Dielectric Withstanding Voltage (耐电压): 500V AC AT Sea Level
 Insulation Resistance (绝缘阻抗): 1000 Megohms MIN
 Operating Temperature (工作温度): -40° C to +105° C
 Housing (塑胶): Temperature Thermoplastics, LCP UL 94V-0 (耐高温塑胶 LCP)
 Contact (端子): Brass (铜) Matte Tin Over Ni (半金锡, 全锡)

Ordering Code:

PFCR01 - X - X - X - X
 ① ② ③ ④ ⑤

① Series No:

④ Color Insulator
B: Black

② No. of Contacts

04=4P 06=6P 08=8P
 10=10P 12=12P 14=14P
 16=16P 18=18P 20=20P
 22=22P 24=24P 26=26P

⑤ Packing
A: Tray
B: Bag
C: Tube
D: Tape Reel

③ Contact Plating

G0: Gold flash S0: Gold flash/Ni
 G1: 3u" Gold S1: 3u" Gold/Ni
 G2: 5u" Gold S2: 5u" Gold/Ni
 G3: 10u" Gold S3: 10u" Gold/Ni
 G4: 15u" Gold S4: 15u" Gold/Ni
 G5: 30u" Gold S5: 30u" Gold/Ni
 SN: Tin

DIMENSION INFORMATION:

NUMBER OF CIRCUITS	DIM A	DIM B
04	8.86	3.81
06	11.40	6.35
08	13.94	8.89
10	16.48	11.43
12	19.02	13.97
14	21.56	16.51
16	24.10	19.05
18	26.64	21.59
20	29.18	24.13
22	31.72	26.67
24	34.26	29.21
26	36.80	31.75

Unless Otherwise specified tolerance

X. XX: ±0.20
 X. X: ±0.25 X. XXX: ±0.15

SCALE: As Shown UNIT: mm

DRAW Wu Feng Rong DATE 日期

CHECK BobYang DATE 日期



Antenk ANTEK ELECTRONICS CO., LTD
 Http://www.antenk.com
 E-mail:sales@antenk.com

TITLE: 1.27mm White IDC Type Angle DIP

DRAWING NO: PFCR01-XXXX

PRODUCT NO: PFCR01-XXXX

REV	DESCRIPTION	DATE
△	7.20+0.05/-0.10 → 7.00+0.10/-0.10	03.06.2020
△	7.00+0.05/-0.10 → 7.20+0.05/-0.10 △ 2.15+0.10/-0.05 → 2.3+0.10/-0.05	03.06.2020